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FDP12N60NZ / FDPF12N60NZ N-Channel UniFETTM II MOSFET 600 V, 12 A, 650 m Ω

Features

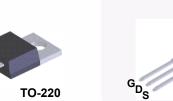
- $R_{DS(on)}$ = 530 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 6 A
- Low Gate Charge (Typ. 26 nC)
- Low C_{rss} (Typ. 12 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

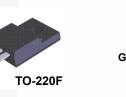
Applications

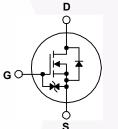
- LCD/ LED/ PDP TV
- Lighting
- Uninterruptible Power Supply

Description

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FDP12N60NZ	FDPF12N60NZ	Unit			
V _{DSS}	Drain to Source Voltage	6	V				
V _{GSS}	Gate to Source Voltage			±;	V		
ID	Desia Current	- Continuous (T _C = 25 ^o C)	- Continuous (T _C = 25 ^o C)		12*	•	
	Drain Current	- Continuous (T _C = 100 ^o C)		7.2	7.2*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	48	48*	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2			5	mJ		
I _{AR}	Avalanche Current		(Note 1)	12		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	24		mJ	
dv/dt	MOSFET dv/dt Ruggedness			2	V/ns		
	Peak Diode Recovery dv/	(Note 3)	10		V/ns		
P _D	Dower Dissinction	(T _C = 25°C)		240	39	W	
	Power Dissipation	- Derate Above 25°C		2.0	0.3	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to	°C		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C		

*Drain current limited by maximum junction temperature

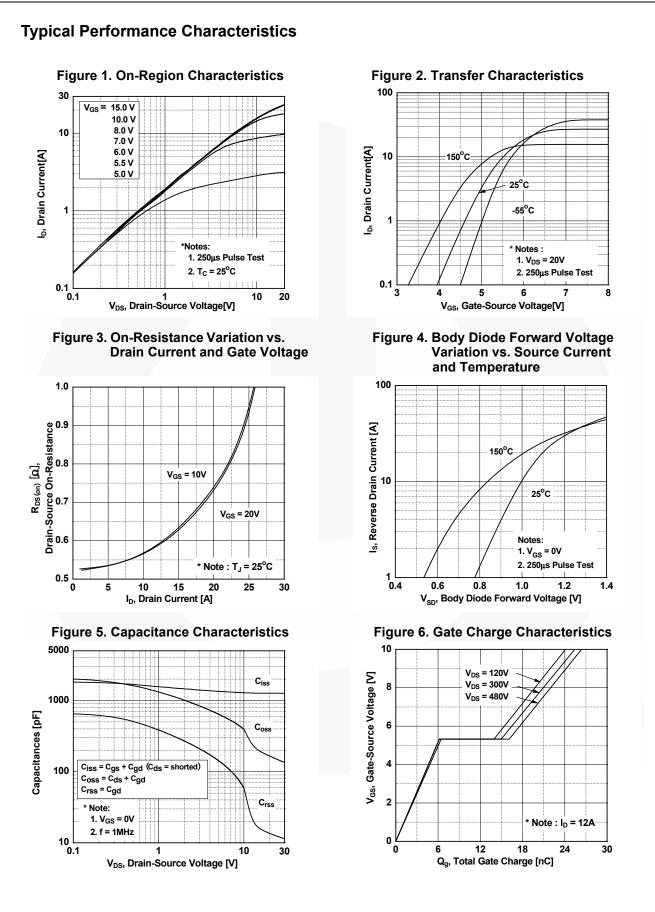
Thermal Characteristics

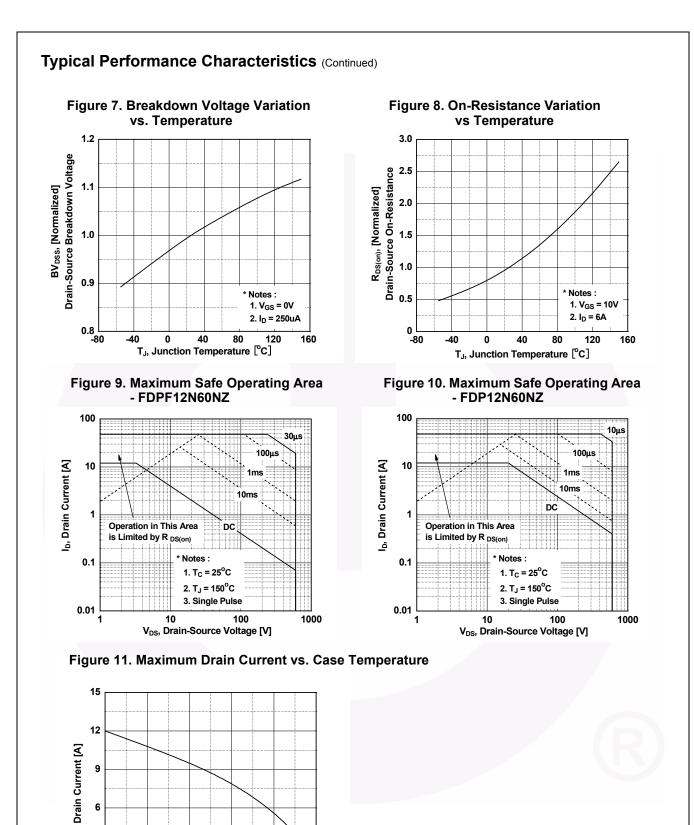
Symbol	Parameter	FDP12N60NZ	FDPF12N60NZ	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.52	3.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	°C/VV

November 2013

Part Nu	Part Number Top Mark		Package	kage Packing Method Reel Size		e Ta	ape Width	Qu	antity
FDP12N60NZ FDP12N60NZ		TO-220	Tube	N/A		N/A	50 units		
		TO-220F Tube N/A		N/A	N/A		50 units		
Electrica	l Chara	acteristics T _C = 25°C	unless oth	erwise noted.					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Charac	teristics						.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
BV _{DSS}		Source Breakdown Voltage	lo i	$= 250 \mu A V_{oo} = 0 V T$	$= 25^{\circ}C$	600	-	-	V
∆BV _{DSS}		wn Voltage Temperature	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V, \ T_J = 25^{\circ}C$		000				
$/\Delta T_J$	Coefficie		I _D :	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.6	-	V/ºC
	Zero Gate Voltage Drain Current			V_{DS} = 600 V, V_{GS} = 0 V		-	-	1	μA
DSS				V_{DS} = 480 V, T_{C} = 125°C			-	10	μΛ
I _{GSS}	Gate to E	e to Body Leakage Current		$_{\rm S}$ = ±30 V, V _{DS} = 0 V		-	-	±10	μA
On Charac	teristics								
V _{GS(th)}	Gate Thr	reshold Voltage	V _G	_S = V _{DS} , I _D = 250 μA		3	-	5	V
R _{DS(on)}	Static Dr	ain to Source On Resistance	-	_S = 10 V, I _D = 6 A		-	0.53	0.65	Ω
9 _{FS}	Forward	Transconductance	-	_S = 20 V, I _D = 6 A		-	13.5	-	S
Dynamic C	haracte	ristics							
C _{iss}	1	pacitance				· -	1260	1676	pF
C _{oss}		apacitance		— V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	150	200	pF
C _{rss}	Reverse	Transfer Capacitance	t =			-	12	18	pF
Q _{g(tot)}	Total Gat	e Charge at 10V	Va	$V_{DS} = 480 \text{ V}, \text{ I}_{D} = 12 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	26	34	nC
Q _{gs}	Gate to S	Source Gate Charge				-	6	-	nC
Q _{gd}	Gate to D	Drain "Miller" Charge				-	10	-	nC
Switching	Charact	eristics							
t _{d(on)}	-	Delay Time		V _{DD} = 300 V, I _D = 12 A,		-	25	60	ns
t _r		Rise Time	VD			-	50	110	ns
t _{d(off)}	Turn-Off Delay Time			$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$			80	170	ns
t _f		Fall Time		(Note 4)		-	60	130	ns
Drain-Sou		e Characteristics							
I _s	1	Continuous Drain to Source	e Diode Fo	rward Current		_	_	12	A
I _{SM}	Maximum Pulsed Drain to Source Diode Fo					-	-	48	A
V _{SD}	Drain to Source Diode Forward Voltage			$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 12 \text{ A}$		-	-	1.4	V
t _{rr}	Reverse Recovery Time			$V_{GS} = 0 V, I_{SD} = 12 A,$		-	350	-	ns
Q _{rr}	Reverse Recovery Charge			$dI_{\rm F}/dt = 100 \text{ A}/\mu \text{s}$		-	2.2	-	μC

2





0 ∟ 25

50

75

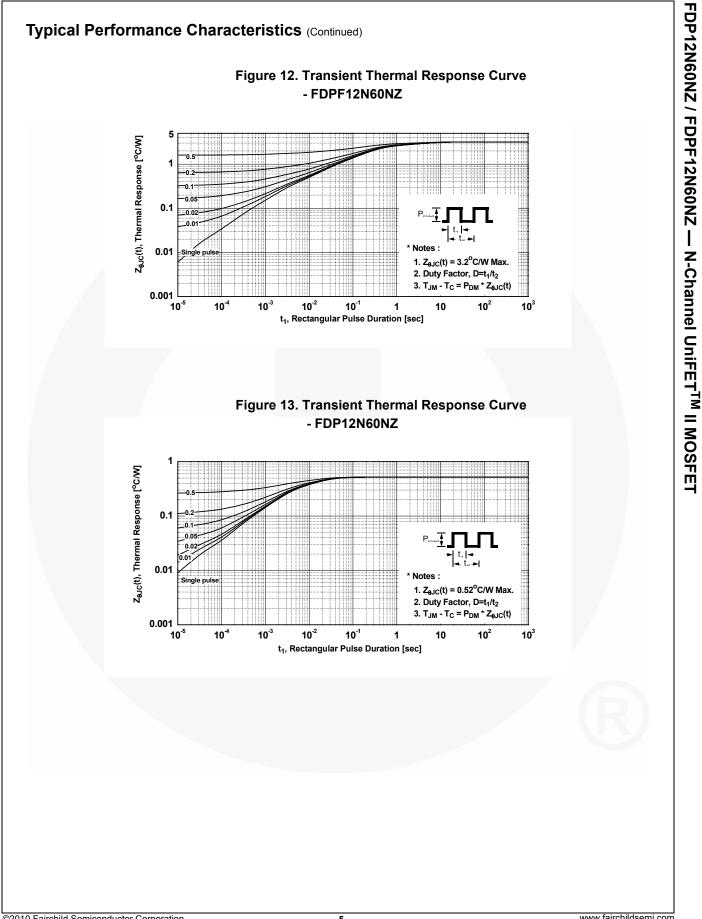
T_c, Case Temperature [°C]

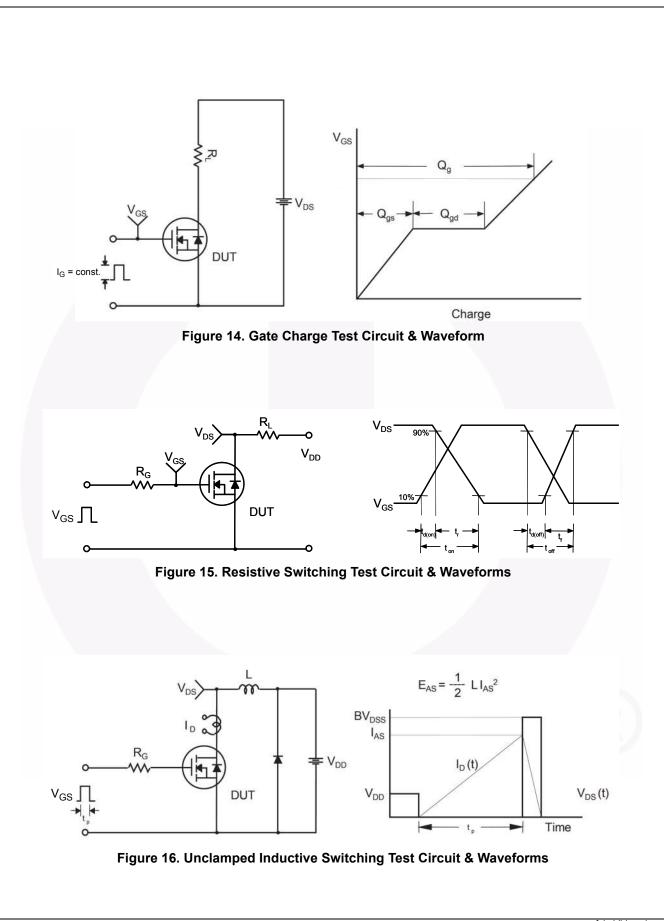
100

125

150

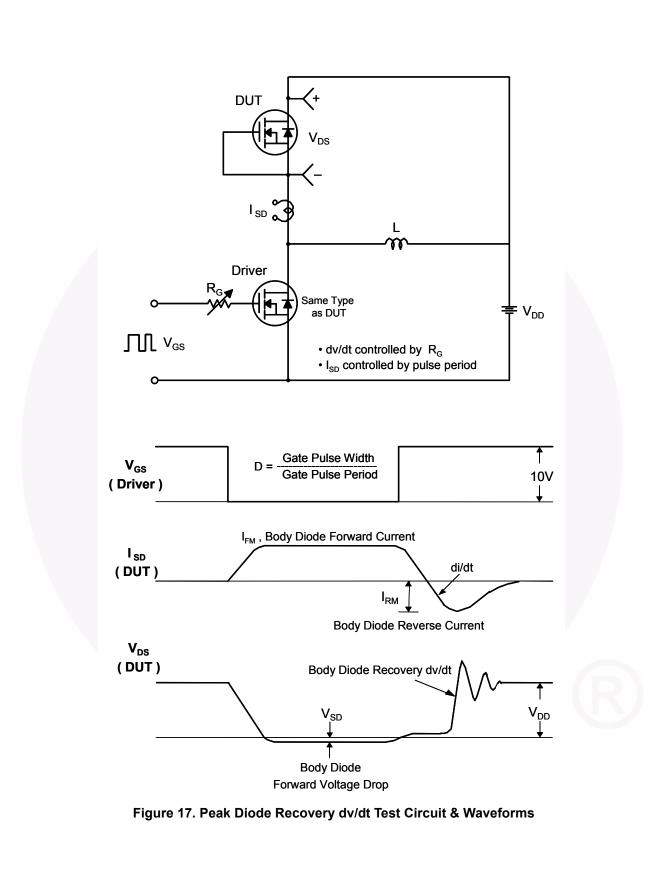
<u>ث</u> 3

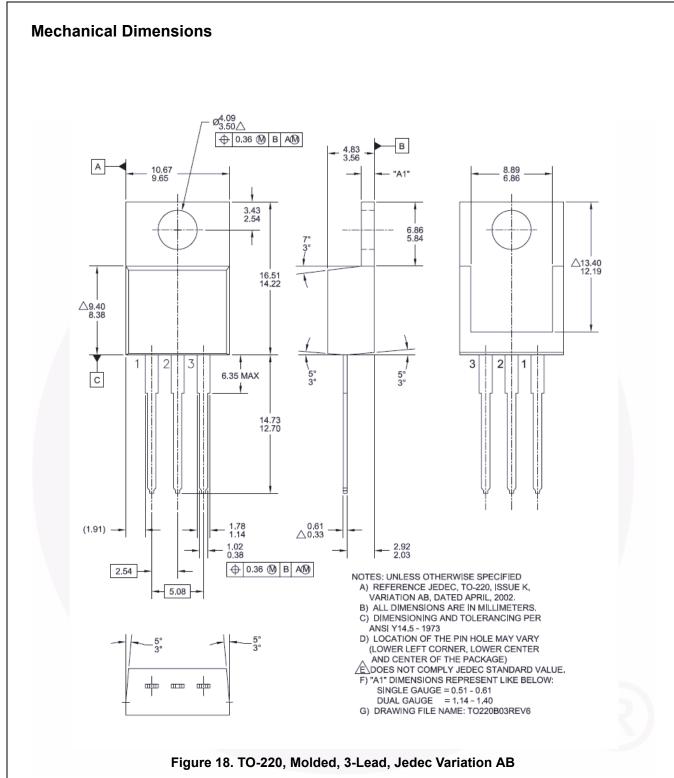




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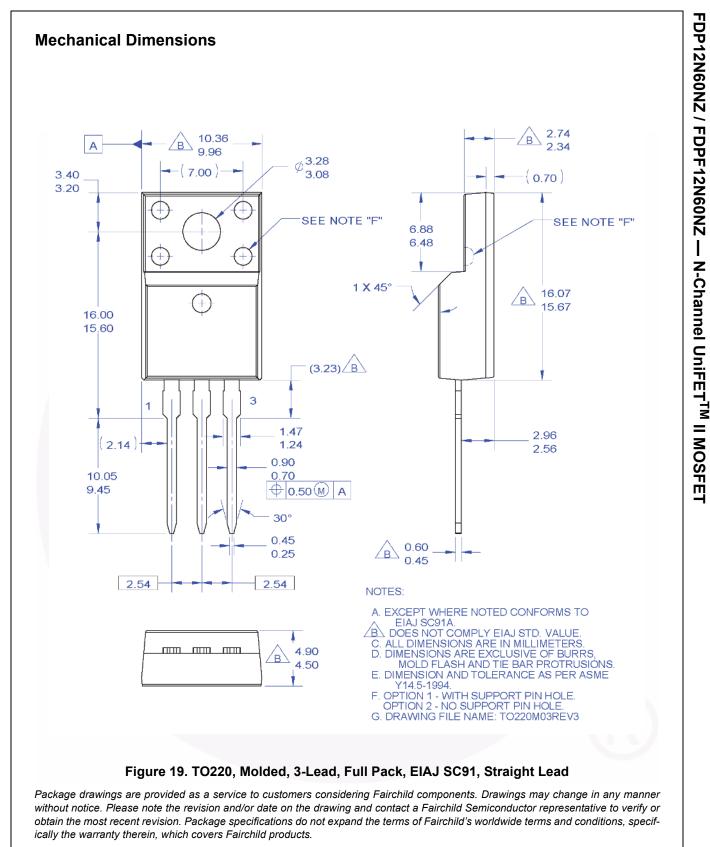


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